

Product Summary

V _{RRM} (V)	I _O (A)	V _F MAX (V)	I _R MAX (μA)
40	0.5	0.46	75

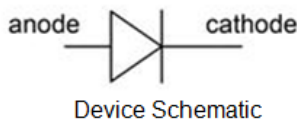
Description

The DIODES™ SDM05U40CSP is a 40-volt 0.5A Schottky barrier rectifier that is optimized for low forward voltage drop and low leakage current, housed in a compact chip scale package (CSP) that occupies only 0.6mm² board-space. The low thermal resistance enables designers to meet design challenges of increasing efficiency whilst at the same time reducing board space.

Applications

Ideally suited for use in portable applications as:

- Blocking diodes
- Boost diodes
- Switching diodes
- Reverse protection diodes

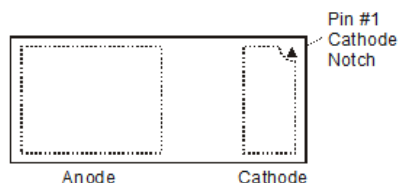


Features and Benefits

- Off Board Profile of 0.275mm – More than 30% Thinner than DFN1006
- Low Forward Voltage (V_F) Minimizes Conduction Losses and Improves Efficiency
- Reduced High Temperature Reverse Leakage; Increased Reliability Against Thermal Runaway Failure in High Temperature Operation
- **Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)**
- **Halogen and Antimony Free. "Green" Device (Note 3)**
- **For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/104/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please [contact us](mailto:contact@diodes.com) or your local Diodes representative. <https://www.diodes.com/quality/product-definitions/>**

Mechanical Data

- Package: X3-WLB1006-2
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: NiAu Bump. Solderable per MIL-STD-202, Method 208 (e4)
- Polarity: Cathode Dot
- Weight: 0.001 grams (Approximate)



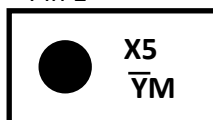
Ordering Information (Note 4)

Part Number	Package	Packing	
		Qty.	Carrier
SDM05U40CSP-7	X3-WLB1006-2	5,000	Reel

- Notes:
1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
 2. See <https://www.diodes.com/quality/lead-free/> for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
 4. For packaging details, go to our website at <https://www.diodes.com/design/support/packaging/diodes-packaging/>.

Marking Information

Pin 1



X5 = Product Type Marking Code
YM or YM = Date Code Marking
Y= Year (ex: J = 2022)
M=Month (ex: 9 = September)
Dot Denotes Cathode Pin

Date Code Key

Year	2013	...	2022	2023	2024	2025	2026	2027	2028	2029	2030	2031
Code	A	...	J	K	L	M	N	O	P	R	S	T
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	O	N	D

Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load.
For capacitive load, derate current by 20%.

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _R	40	V
Average Rectified Output Current	I _O	0.5	A
Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load	I _{FSM}	14	A

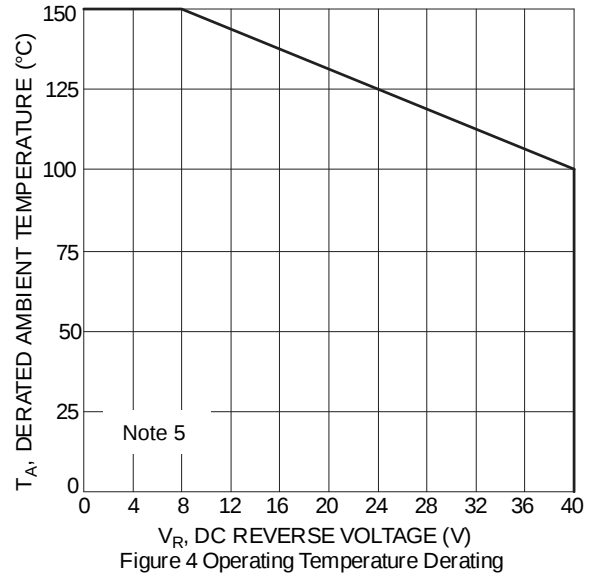
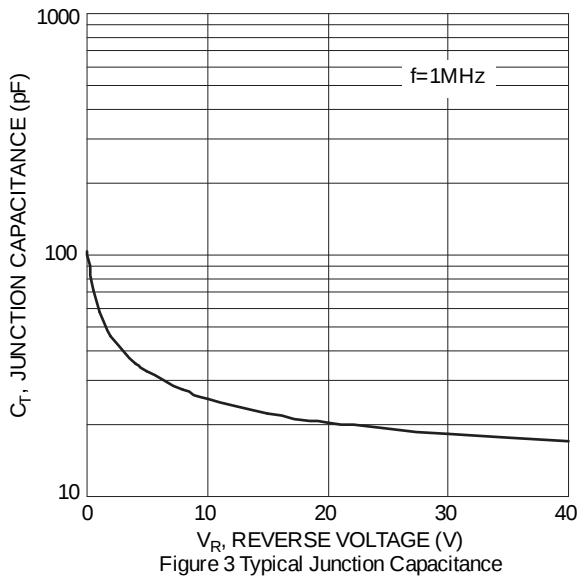
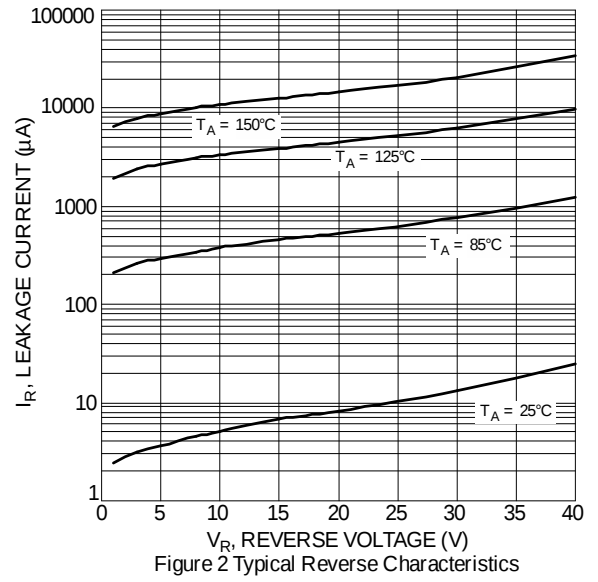
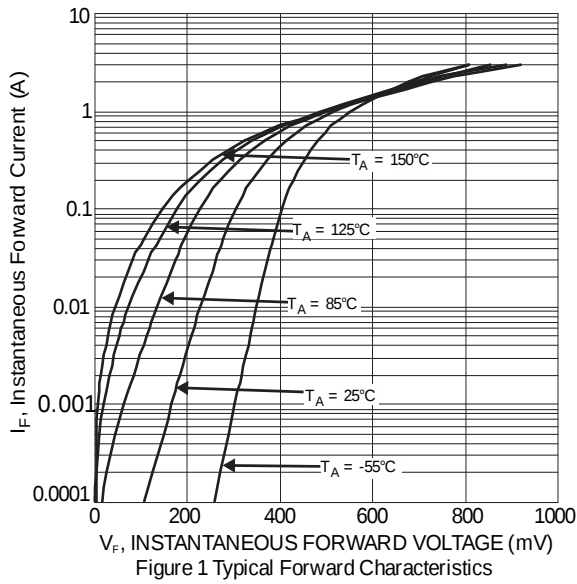
Thermal Characteristics

Characteristic	Symbol	Value	Unit
Typical Thermal Resistance Junction to Ambient (Note 5)	R _{θJA}	135	°C/W
Typical Thermal Resistance Junction to Case (Note 5)	R _{θJC}	8	°C/W
Typical Thermal Resistance Junction to Ambient (Note 6)	R _{θJA}	80	°C/W
Typical Thermal Resistance Junction to Case (Note 6)	R _{θJC}	3	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-55 to +150	°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

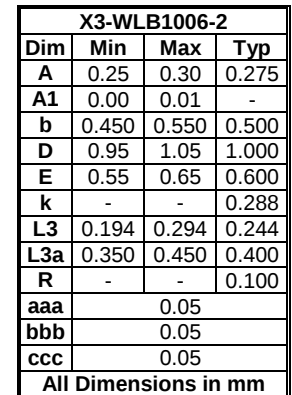
Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
Forward Voltage Drop	V _F	—	0.305	0.36	V	I _F = 0.1A
		—	0.415	0.46		I _F = 0.5A
		—	0.34	—		I _F = 0.5A, T _J = +125°C
Leakage Current (Note 7)	I _R	—	—	15	μA	V _R = 10V
		—	—	75		V _R = 40V
Junction Capacitance	C _T	—	35	—	pF	V _R = 4V, f = 1.0MHz

Notes: 5. Device mounted on FR-4 PCB, 2oz. Copper, minimum recommended pad layout per <http://www.diodes.com/package-outlines.html>.
6. Device mounted on FR-4 PCB, 2oz. 1 square inch copper.
7. Short duration pulse test used to minimize self-heating effect.



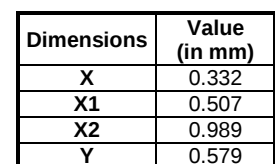
Please see <http://www.diodes.com/package-outlines.html> for the latest version.

X3-WLB1006-2



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X3-WLB1006-2



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